

Background of the invention

The invention relates to an optical waveguide which is
5 structured in a core layer which is located on a buffer
layer and is covered by a cladding layer, the buffer layer
being applied to a substrate, an optical component which is
constructed on a substrate and is provided at least
partially with a cladding layer and to two processes for
10 producing a waveguide of this type according.

The invention is based on a priority application DE 100 41
174.6 which is hereby incorporated by reference.

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Summary of the invention

Optical glass waveguides which are used in optical
components such as an arrayed waveguide grating (AWG), a
directional coupler or a star coupler, are produced by
20 structuring a core layer doped, for example, with boron,
phosphorus or germanium. This core layer is applied to a
buffer layer. The latter consists, for example, of silicate
(SiO_2) and is grown by oxidation under high-pressure steam
on a silicon substrate (Si). This buffer layer serves to
25 insulate the core layer from the silicon substrate which
has a very high refractive index. The optical waveguides
are structured, for example, by dry etching into the core
layer and are then covered by a cladding layer several μm
30 thick and made of silicate glass doped with boron,
phosphorus or germanium.

Planar optical waveguides of this type in silicate glass
have many applications in optical components for
telecommunications. Generally however, these glass layers
35 and therefore the optical components produced therefrom are
not birefringence-free. This leads to uncontrollable

polarisation-dependent losses in optical systems which are unacceptable when perfect operation is required.

In the meantime it has become known that the birefringence 5 in the optical waveguide, which causes the TE-wave (electrical transversal component of the electromagnetic wave) of the optical signal to spread at a different speed in the waveguide compared with the TM-wave (magnetic transversal component of the electromagnetic wave), can be 10 attributed to the use of silicon as substrate. The various thermal coefficients of expansion of glass layer and substrate material generally lead in the high temperature processes of glass production to thermally induced stresses in the glass layer which lead to birefringence.

15 The use of a glass substrate (SiO_2) instead of silicon allows the stress and therefore the birefringence to be reduced but it is still too high for practical applications (S. Suzuki, Y. Inoue and Y. Ohmori, Elect. Lett., Vol. 30, 20 No. 8 (1994), pp. 642-643). A process is also known in which in a plurality of additional process steps grooves are subsequently etched into the finished optical component to compensate for the stresses (E. Wildermuth et al, Electronics Lett., Vol. 34, No. 17 (1998), pp. 1661-1662).

25 Here, however, a process is aspired to in which the birefringence is already compensated during production of the glass layers and waveguides without additional process steps. Based on the publications by S. Suzuki et al, 30 Electronics Lett., Vol. 33, No. 13, pp. 1173-1174 and S.M. Ojha et al, Electr. Lett., 34(1), (1998), pp. 78, a process is described in the article by Kilian et al, J. Lightw. Technol. Vol. 18(2), (2000), pp. 193 for producing birefringence-free planar optical waveguides. The process 35 is based on the use of flame hydrolysis deposition (FHD) to cover the waveguides with a cladding layer. In this case, the cladding layer consists of highly doped silicate glass

SiO_2 . Boron and phosphorus, for example, are used as dopants to adjust the refractive index. The quantity of boron atoms used allows the thermal expansion of the cladding layer to be increased such that cladding layer and silicon substrate
5 have approximately the same thermal coefficient of expansion. It could be shown that optical waveguides have birefringence-free properties when the thermal coefficients of expansion of the cladding layer and of the substrate are the same.

10 This result was calculated with the aid of stress and mode simulation and is shown in Fig. 1. Fig. 1 shows the effective refractive indices of the TE-mode and TM-mode and the resulting birefringence (difference in the mode indices
15 $n_{\text{TE}} - n_{\text{TM}}$) versus the thermal coefficient of expansion of the cladding layer. With a thermal coefficient of expansion of the cladding layer of $3.65 \times 10^{-6} \text{ K}^{-1}$, which almost corresponds to the value of the thermal coefficient of expansion of the silicon substrate of $3.6 \times 10^{-6} \text{ K}^{-1}$, the
20 resulting birefringence is zero.

25 The quantity of boron atoms used as dopant in this case in order to achieve a birefringence-free waveguide leads to sensitivity to moisture in the doped cladding layer. As a result, optical modules which are provided with a cladding layer of this type are unstable with respect to moisture and this can even lead to destruction of the cladding layer (crystallising out) and therefore of the entire optical component. A solution to this is provided if an additional
30 protective layer is applied to the cladding layer, but moisture can still attack the cladding layer at the edges of such optical modules.

35 The invention is based on the object of producing optical waveguides integrated in optical modules which have a birefringence which is as low as possible, this property of

birefringence and the component's stability to moisture enduring over a long period.

The object is achieved according to the invention by an
5 optical waveguide which is structured in a core layer which
is located on a buffer layer and is covered by a cladding
layer, the buffer layer being applied to a substrate,
wherein a strip-shaped waveguide base of thickness d is
formed between buffer layer and optical waveguide, which
10 waveguide base is completely covered laterally by the
cladding layer and has the optical waveguide structured
thereon, and the cladding layer consists of a vitreous
material doped with foreign atoms to impart a
birefringence-free property to the optical waveguide, an
15 optical component which is constructed on a substrate and
is provided at least partially with a cladding layer,
wherein the optical component has an optical waveguide as
described above and by a process for producing an optical
waveguide in which a buffer layer is applied to a
20 substrate, to which buffer layer a core layer is applied,
the optical waveguide being structured into the core layer,
wherein a strip-shaped waveguide base of thickness d is
formed from the buffer layer below the optical waveguide,
and in that subsequently both the optical waveguide and the
25 portion of the waveguide base not covered by the waveguide
is covered by a cladding layer and a process for producing
an optical waveguide in which a first buffer layer is
applied to a substrate, to which first buffer layer a core
layer is applied, the optical waveguide being structured
30 into the core layer, wherein a further buffer layer is
applied to the first buffer layer before the core layer is
applied, from which further buffer layer a strip-shaped
waveguide base of thickness d is formed, and in that
subsequently both the optical waveguide and the portion of
35 the waveguide base not covered by the waveguide is covered
by a cladding layer.

Application of an optical waveguide along a strip-shaped structured buffer layer, formed as a waveguide base, allows a reduction in the thermal coefficient of expansion of the cladding layer with simultaneous birefringence-compensated 5 waveguide. Accordingly, the quantity of dopants (for example boron atoms) no longer has to be so large for the cladding layer. This has the enormous advantage that optical components which comprise optical waveguides of this type remain birefringence-free for a long period for 10 optical signals transmitted in the optical waveguides, and the cladding layer is moisture resistant.

The invention minimises in a simple manner the negative effects produced by the difference between the coefficients 15 of expansion of the substrate and the waveguide. In the ideal case it is sufficient for this purpose to provide a waveguide base of a certain thickness. A suitable cladding layer is also advantageously selected, for example in a doped cladding layer the doping is appropriately selected 20 to optimise the minimisation. Silicon, quartz glass, ceramic or a polymer, for example, can be used as substrate. An optical material, an amorphous optical material, glass or a primer for example is used as cladding layer. An optical material, an amorphous optical material, 25 glass or a polymer for example is used as waveguide. An optical material, an amorphous optical material, glass or a polymer for example is used as buffer layer. The waveguide base is formed in one configuration from the buffer layer already formed, for example by etching. The waveguide base 30 is accordingly made of the same material as the buffer layer.

Brief description of the drawings

35 Advantageous configurations of the inventions emerge from the dependent claims, the following description and the

drawings. Two embodiments of the invention will now be described with the aid of Fig. 1 to 5, in which:

Fig. 1 shows a graph of the effective refractive index
for TE- and TM-modes and the resulting
birefringence of an optical signal in an optical
waveguide produced according to the state of the
art as a function of the thermal coefficient of
expansion (TCE) of the cladding layer,

Fig. 2 shows a cross-section of an optical waveguide
according to the invention,

Fig. 3 shows a graph of the effective refractive index
of the TE- and TM-modes of an optical signal
transmitted in the optical waveguide according to
the invention and the resulting birefringence as
a function of the thickness of the waveguide base
of the buffer layer,

Fig. 4 shows a graph of the thickness of the waveguide
base of the buffer layer as a function of the
thermal coefficient of expansion (TCE) of the
cladding layer of the optical waveguide according
to the invention, and

Fig. 5 shows a cross-section of three optical waveguides
according to the invention.

The first embodiment will now be described with the aid of
Fig. 1 to 4. As known in the state of the art up until now
and as can clearly be seen from the graph in Fig. 1,
freedom from birefringence can only be achieved in optical
waveguides which are constructed on a silicon substrate if
the coefficient of expansion of the cladding layer has
approximately the same value as that of the silicon
substrate. With a value of $3.6 \times 10^{-6} \text{ K}^{-1}$ for the thermal

coefficient of expansion of the silicon substrate the cladding layer has to have a coefficient of expansion of $3.65 \times 10^{-6} \text{ K}^{-1}$; K = Kelvin.

5 Fig. 2 shows an optical waveguide 1 according to the invention of an optical component, such as e.g. a star coupler, directional coupler or arrayed waveguide grating, in cross-section. This optical waveguide 1 is etched in a core layer. This core layer rests on a buffer layer 2 which
10 is itself applied to a silicon substrate 3. Both the waveguide 1 and at least portions of the rest of the buffer layer 2 which are exposed are covered by a cladding layer 4. The cladding layer 4 consists of a vitreous material, preferably silicate (SiO_2) which is accordingly doped with
15 dopants. Boron atoms are primarily used in this case in order to increase the thermal coefficient of expansion of the silicate until the optical waveguide 1 according to the invention exhibits birefringence-free properties. Other
15 dopants are optionally used in addition to the boron atoms,
20 such as e.g. phosphorus atoms, in order to be able to adjust the refractive index.

As can be seen in Fig. 2 the optical waveguide 1 according to the invention does not rest directly on a plane face of
25 the buffer layer 2 but on a strip-shaped waveguide base 5 of this buffer layer 2. Accordingly, the optical waveguide 1 according to the invention rests directly on this waveguide base 5 which extends, like the optical waveguide 1, over the entire optical component in the longitudinal
30 direction (not shown in Fig. 2).

This waveguide base 5 of the buffer layer 2 is advantageously produced during etching (for example dry etching) of the optical waveguide 1 from the core layer.
35 The thickness d of this waveguide base 5 can vary as a function of the depth of the etching process applied via the core layer into the buffer layer 2. It has turned out

that application of the optical waveguides 1 to strip-shaped waveguide bases 5 of this type leads to the cladding layer 4 covering it requiring a smaller thermal coefficient of expansion for birefringence-free optical waveguides 1.

- 5 As a result, the quantity of dopants, advantageously boron atoms, can be smaller to arrive at a cladding layer which has the desired thermal coefficient of expansion. The cladding layer 4 completely covers the optical waveguide 1 and the sides of the strip-shaped waveguide base 5.

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Fig. 3 shows a graph of the effective refractive index of the TE- and TM-modes and the resulting birefringence (given by the subtraction of the effective refractive index of the TE-mode from that of the TM-mode) as a function of the

- 15 thickness d of the waveguide base 5 from the buffer layer 2 for a thermal coefficient of expansion of the cladding layer 4 of $3.45 \times 10^{-6} \text{ K}^{-1}$ reduced with respect to that of the silicon substrate ($3.6 \times 10^{-6} \text{ K}^{-1}$). The graph in Fig. 3 shows that the optical waveguide 1 will exhibit a
20 birefringence-free property if the waveguide base has a thickness of $0.8 \mu\text{m}$.

- It is quite possible to produce birefringence-free optical waveguides with a cladding layer which has an even smaller
25 thermal coefficient of expansion. For example, for a thickness of the waveguide base of $1.1 \mu\text{m}$ the optical waveguide 1 located thereon will have birefringence-free properties if the thermal coefficient of expansion of the cladding layer achieves only $3.35 \times 10^{-6} \text{ K}^{-1}$, as shown in
30 Fig. 4. The thickness of the waveguide base 5 in μm is shown in a graph in Fig. 4 as a function of the thermal coefficient of expansion of the cladding layer for birefringence-free waveguides, which thickness is scaled by a factor of 10^{-6} .

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Owing to this knowledge about the influence of a waveguide base on the optical waveguide located thereon, a process

for producing optical waveguides of this type in optical components such as e.g. star couplers, directional couplers or arrayed waveguide gratings can be selected in which the quantity of foreign atoms (dopants) is selected as a

5 function of the thickness d of the waveguide base 5. In this case, the fewer the number of foreign atoms used, the greater the thickness d of this waveguide base. The thermal coefficient of expansion of the cladding layer is selected in a similar manner as a function of the thickness d of the 10 waveguide base 5. In this case the greater this thickness d , the lower the thermal coefficient of expansion of the cladding layer 4 (in comparison with the thermal coefficient of expansion of the substrate).

15 The decision to structure optical waveguides on a waveguide base of the buffer layer advantageously facilitates the use of few foreign atoms (dopants) for the cladding layer. Consequently, the great disadvantage of sensitivity to moisture of cladding layers which have been doped, for 20 example, with boron atoms is eliminated. Therefore, optical waveguides, which exhibit a stable birefringence-free property over time, can be successfully produced without additional production steps, such as e.g. an additional protective layer, being required.

25 In the first embodiment the width of the waveguide base is equal to the width of the waveguide. Alternatively, waveguide and waveguide base can also be of different widths. The different widths can be produced by at least 30 one additional suitable structuring process, for example masking and/or etching. For a waveguide base wider than the waveguide, the waveguide and a partial region of the buffer layer would be covered, for example after structuring of the waveguide, and subsequently the waveguide base would be 35 formed by etching the partial region of the buffer layer not covered.

The second embodiment will now be described with the aid of Fig. 5. Fig. 5 shows a cross-section of three optical waveguides according to the invention. A buffer layer 2 is applied to a substrate 3. Three waveguide bases 5 are structured on the buffer layer 2, the waveguide bases 5 being formed from the same material as the buffer layer 2. The waveguide bases 5 are produced, for example by etching the buffer layer, the depth of the etching corresponding to the thickness d. The three waveguides 1 are structured on the three waveguide bases. During production, the three waveguides 1 are structured, for example, initially on the buffer layer 2, from which the waveguide bases 5 can then subsequently be formed by covering and etching. The waveguide bases 5 in the second embodiment are wider than the waveguides 1. A cross-section is shown in Fig. 5. In longitudinal direction the waveguides 1 can, for example, extend linearly, in a curved manner, sinusoidally or in another way. These types of waveguides are designated strip-shaped waveguides irrespective of their mode of extension in the longitudinal direction. The widths of the waveguide bases 5 are ideally adapted to the widths of the waveguides 1 in the longitudinal direction. If waveguides 1 and waveguide bases 5 have, for example, the same width and the waveguides 1 extend in a curved manner in the longitudinal direction, then the waveguide bases 5 have a profile in the longitudinal direction adapted to this curved profile. In the case of etching of the waveguide profiles and waveguide base profiles in a structuring step, this curved profile automatically forms so as to be accordingly adapted. Finally, a cladding layer 4 is applied to buffer layer 2, waveguide base 5 and waveguide 1.

In the two embodiments the waveguide base is made of the same material as the buffer layer. Alternatively, the waveguide base can also consist of a different material. The material of the waveguide base is selected such that it does not affect the optical light guidance. Any doped